

# DIFFERENTIAL PAIR ARRAY DEAM SERIES

#### **SPECIFICATIONS**

For complete specifications and recommended PCB layouts see www.samtec.com?DPAM

Insulator Material: Black LCP
Contact Material:
Copper Alloy

Plating:

Au over 50μ" (1,27μm) Ni Current Rating (2x3): 2.9A @ 30°C Temperature Rise Operating Temp Range: -55°C to +125°C

**Contact Resistance:** 10.4mΩ max Working Voltage: 300 VAC

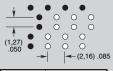
Mated Cycles: 100 Cycles RoHS Compliant: Yes

## **Processing:**

Max Processing Temp: 230°C for 60 seconds, or 260°C for 20 seconds 3x Lead-Free Solderable:

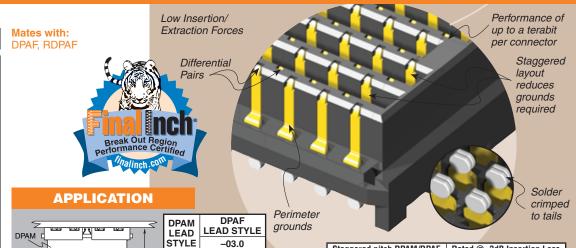


### **DIFFERENTIAL** APPLICATIONS



ARRAY	PAIR COUNT*
8x8	48
15x8	104
23x8	168
08x3	18
15x3	39
23x3	63
*Assumes first and last pair in	

Note: Some sizes, styles and options are non-standard, non-returnable.





NO. OF

**ROWS** 

**PLATING** 

**OPTION** 



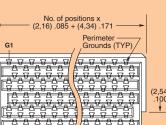
**PER ROW** 

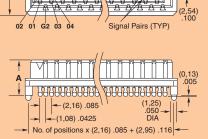
**DPAM** 

Specify LEAD **STYLE** from

**LEAD** 

STYLE





#### -H 30μ" (0,76μm) Gold on contact area, **Gold Flash** chart on solder tail

-S 30μ" (0,76μm) Gold on contact area, Tin on solder tail (-11 & -14 only)

**LEAD** 

-07.0

-11.0

(6,66) .262 (10,72) .422

**-14.0** (13,66) .538

Pair Rows -3 (-07 only) =Three Pair Rows -07 only

-8 =Eight Lead-Free Tin Alloy 96.5% Sn/ 3% Ag/ .5% Cu Solder Crimp

SOLDER

**TYPE** 

(20,00 mm) 0.80" DIA Polyimide film Pick & Place Pad

OPTION

-TR =Tape & Reel

-GP =Guide Post (–23 only & –07 only)



## **ALSO AVAILABLE**

Tin-Lead Solder Charge. Call Samtec.

Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM